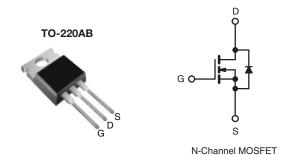


### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	400			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 1.0			
Q <sub>g</sub> (Max.) (nC)	38			
Q <sub>gs</sub> (nC)	5.7			
Q <sub>gd</sub> (nC)	22			
Configuration	Single			



### **FEATURES**

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Fast Switching
- · Ease of Paralleling
- Simple Drive Requirements
- Compliant to RoHS Directive 2002/95/EC



#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF730PbF		
Lead (FD)-lifee	SiHF730-E3		
SnPb	IRF730		
OIIF D	SiHF730		

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub>	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		$V_{DS}$	400	V		
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	\/ -+ 10\/	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$		5.5		
Continuous Drain Current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	3.5	Α	
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	22		
Linear Derating Factor				0.59	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	290	mJ	
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	5.5	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	74	W	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C		
Soldering Recommendations (Peak Temperature) for 10 s			300 <sup>d</sup>			
Mounting Torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 16 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 5.5 A (see fig. 12). c.  $I_{SD} \le 5.5$  A,  $dI/dt \le 90$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 150$  °C. d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7		

PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static					•	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	) V, I <sub>D</sub> = 250 μA	400	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.54	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = \	/ <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	Vo	<sub>SS</sub> = ± 20 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>		00 V, V <sub>GS</sub> = 0 V	-	-	25	μA
<u> </u>		$V_{DS} = 320 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$		-	250	)   []	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 3.3 \text{ A}^b$	-	-	1.0	Ω
Forward Transconductance	9 <sub>fs</sub>	$V_{DS} = 5$	50 V, I <sub>D</sub> = 3.3 A <sup>b</sup>	2.9	-	-	S
Dynamic							
Input Capacitance	$C_{iss}$	$V_{GS} = 0 V$ ,		-	700	-	pF
Output Capacitance	C <sub>oss</sub>	V	$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$ f = 1.0  MHz,  see fig.  5		170	-	
Reverse Transfer Capacitance	$C_{rss}$	f = 1.0			64	-	
Total Gate Charge	$Q_g$			-	-	38	
Gate-Source Charge	$Q_{gs}$	V <sub>GS</sub> = 10 V	$I_D = 3.5 \text{ A}, V_{DS} = 320 \text{ V},$ see fig. 6 and 13 <sup>b</sup>	-	-	5.7	nC
Gate-Drain Charge	$Q_{gd}$			-	-	22	
Turn-On Delay Time	t <sub>d(on)</sub>			-	10	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 2$	200 V, I <sub>D</sub> = 3.5 A	-	15	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 12 \Omega, R$	$_{\rm D}$ = 57 $\Omega$ , see fig. 10 <sup>b</sup>	-	38	-	1115
Fall Time	t <sub>f</sub>	$R_g = 12 \ \Omega, R_D = 57 \ \Omega, \text{ see fig. } 10^b$ - 38 - 14		-	٦		
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	Ls			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbo	ol P	-	-	5.5	A
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		Ī	-	22	
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C, I	$_{S} = 5.5 \text{ A}, V_{GS} = 0 \text{ V}^{b}$	1	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	- 270 53		530	ns		
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_{.1} = 25 ^{\circ}\text{C}, I_{F} = 3.5 \text{A},  \text{dI/dt} = 100 \text{A/}\mu\text{s}^{\text{b}}$		2.2	μC		
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn	ı-on time is negligible (turn	-on is do	minated h	v I o and	1-2)

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300 \ \mu s$ ; duty cycle  $\leq 2 \ \%$ .



### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

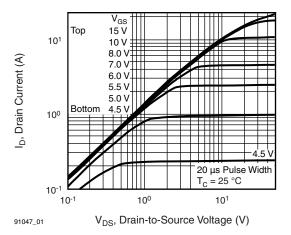


Fig. 1 - Typical Output Characteristics,  $T_C = 25$  °C

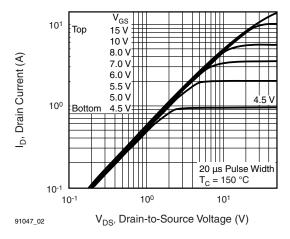


Fig. 2 - Typical Output Characteristics, T<sub>C</sub> = 150 °C

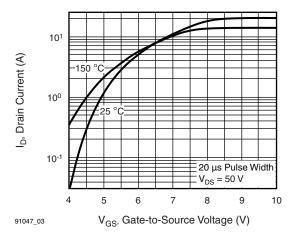


Fig. 3 - Typical Transfer Characteristics

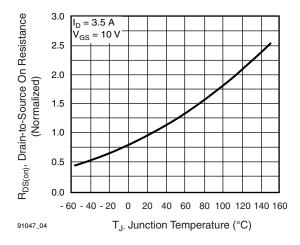


Fig. 4 - Normalized On-Resistance vs. Temperature



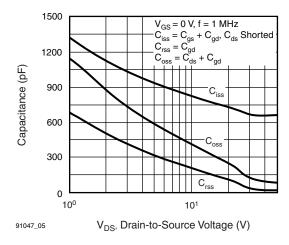
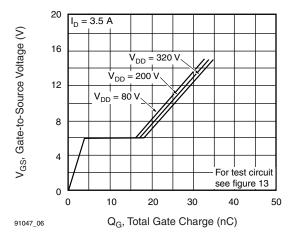


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

Fig. 7 - Typical Source-Drain Diode Forward Voltage



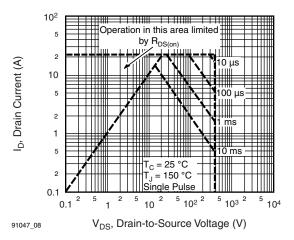
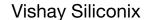


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

Fig. 8 - Maximum Safe Operating Area





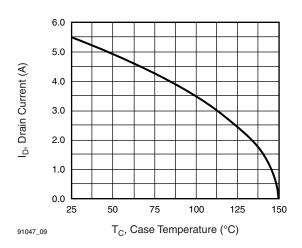


Fig. 9 - Maximum Drain Current vs. Case Temperature

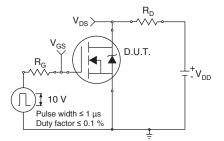


Fig. 10a - Switching Time Test Circuit

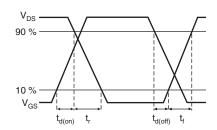


Fig. 10b - Switching Time Waveforms

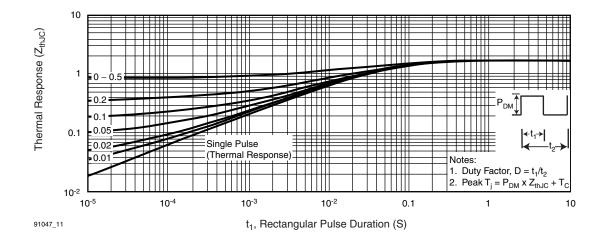


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



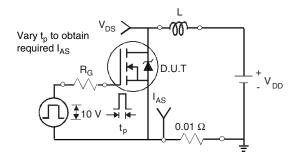


Fig. 12a - Unclamped Inductive Test Circuit

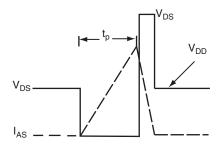


Fig. 12b - Unclamped Inductive Waveforms

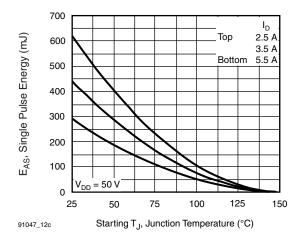


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

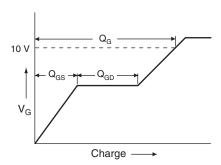


Fig. 13a - Basic Gate Charge Waveform

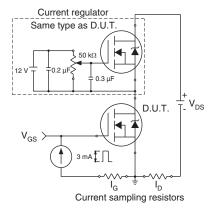
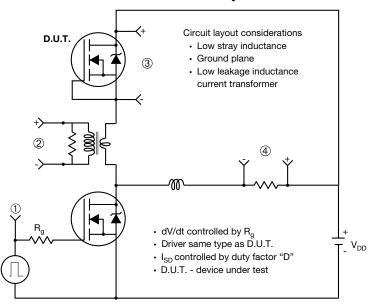


Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



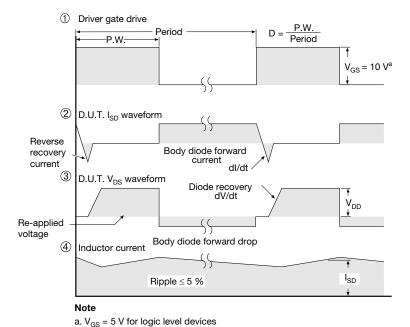


Fig. 14 - For N-Channel

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## TO-220-1



DIM.	MILLIN	METERS	INCHES		
DIIVI.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

#### Note

 $\bullet$   $M^{\star}=0.052$  inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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